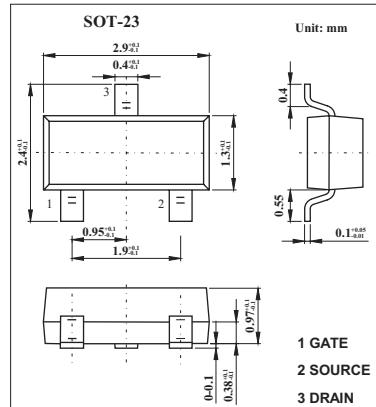
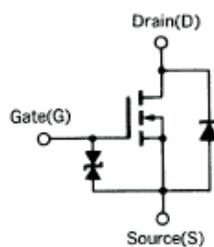


MOS Field Effect Transistor

2SK1133

■ Features

- Directly driven by Ics having a 5V power source.
- Not necessary to consider driving current because of its high input impedance.
- Possible to reduce the number of parts by omitting the biasresistor.



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Drain to source voltage	V _{DSS}	50	V
Gate to source voltage	V _{GSS}	±7.0	V
Drain current (DC)	I _D	±100	mA
Drain current(pulse) *	I _D	±200	mA
Power dissipation	P _D	200	m W
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

* PW ≤ 10ms, duty cycle ≤ 50%

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Drain cut-off current	I _{DSS}	V _D =50V,V _G =0			-10	μ A
Gate leakage current	I _{GSS}	V _G =±7V,V _D =0			±10	μ A
Gate to source cutoff voltage	V _{G(off)}	V _D =5.0V,I _D =1 μ A	1.0	1.7	2.0	V
Forward transfer admittance	Y _{fs}	V _D =5.0V,I _D =20mA	20	40		ms
Drain to source on-state resistance	R _{D(on)}	V _G =4V,I _D =20mA		16	50	Ω
Input capacitance	C _{iss}	V _D =5.0V,V _G =0,f=1MHZ		7		pF
Output capacitance	C _{oss}			6		pF
Reverse transfer capacitance	C _{rss}			2		pF
Turn-on delay time	t _{d(on)}	V _{G(on)} =0,V _D =5V,f=1MHz		6		ns
Rise time	t _r			25		ns
Turn-off delay time	t _{d(off)}			36		ns
Fall time	t _f			35		ns

■ Marking

Marking	G11
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